



Features

#### N-CHANNEL ENHANCEMENT MODE MOSFET

LD-MOS technology with the lowest Figure of Merit:  $R_{DS(on)} = 18m\Omega$  to minimize on-state losses

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

Qualified to AEC-Q101 Standards for High Reliability

 $\label{eq:Qg} Q_g = 3.2 nC \mbox{ for ultra-fast switching} \\ V_{gs(th)} = 0.8 V \mbox{ typ. for a low turn-on potential}$ 

Terminal Connections: See Diagram Below

CSP with Footprint 1.0mm × 1.0mm Height = 0.62mm for Low Profile

## **Product Summary**

V <sub>DSS</sub>	R <sub>DS(on)</sub>	Qg	Q <sub>gd</sub>	ID
12V	18mΩ	3.2nC	0.3nC	4.8A

Typ. @ V<sub>GS</sub> = 4.5V, T<sub>A</sub> = +25°C

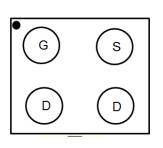
## Description

This  $2^{nd}$  generation Lateral MOSFET (LD-MOS) is engineered to minimize on-state losses and switch ultra-fast, making it ideal for high efficiency power transfer. It uses Chip-Scale Package (CSP) to increase power density by combining low thermal impedance with minimal  $R_{DS(on)}$  per footprint area.

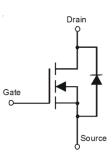
# Applications

- DC-DC Converters
- Battery Management
- Load Switch

U-WLB1010-4



Top View



**Mechanical Data** 

Case: U-WLB1010-4

Equivalent Circuit

### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1032UCB4-7	U-WLB1010-4	3,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**

#### U-WLB1010-4



MW = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: B = 2014) M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

-												
Year	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	В	С	D	E	F	G	Н		J	K	L	М
	_											
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	۲ ۲	4	5	6	7	8	Q	0	N	П



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	12	V		
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Continuous Drain Current (Note 5) $V_{GS}$ = 4.5V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	4.8 3.8	A
Continuous Drain Current (Note 5) V <sub>GS</sub> = 2.5V	ID	4.5 3.6	А		
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	15	A		

# **Thermal Characteristics**

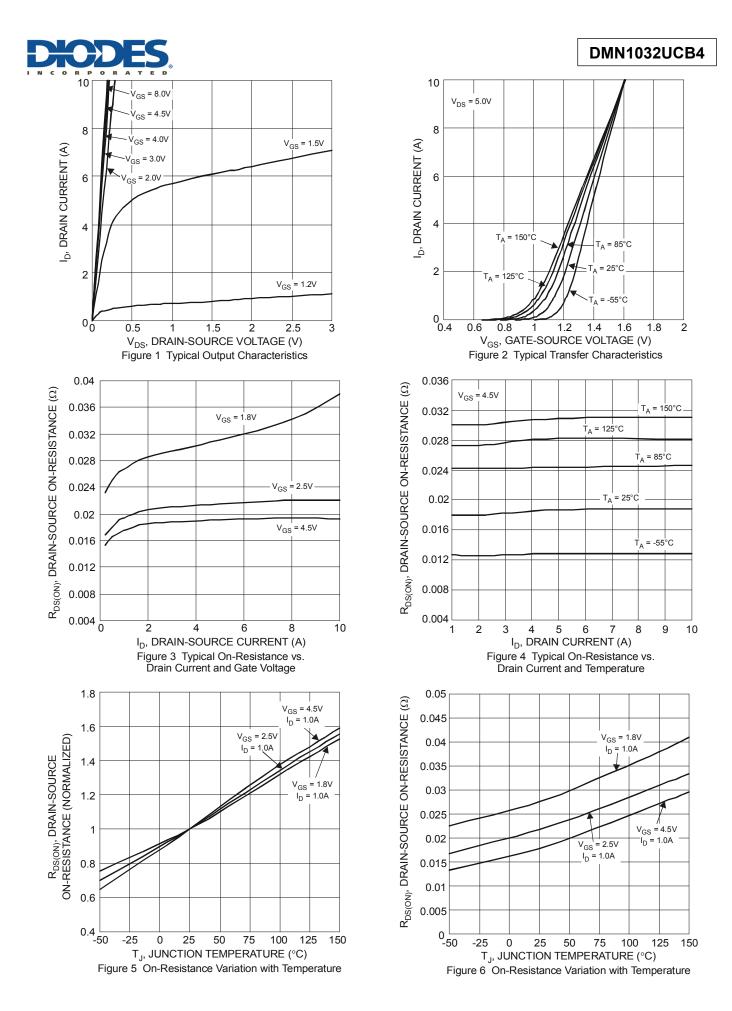
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	0.9	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 7)	R <sub>0JA</sub>	138.81	°C/W
Thermal Resistance, Junction to Case $@T_C = +25^{\circ}C$ (Note 7)	R <sub>0JC</sub>	31.77	°C/W
Power Dissipation (Note 5)	PD	1.16	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R <sub>0JA</sub>	107.59	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

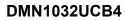
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

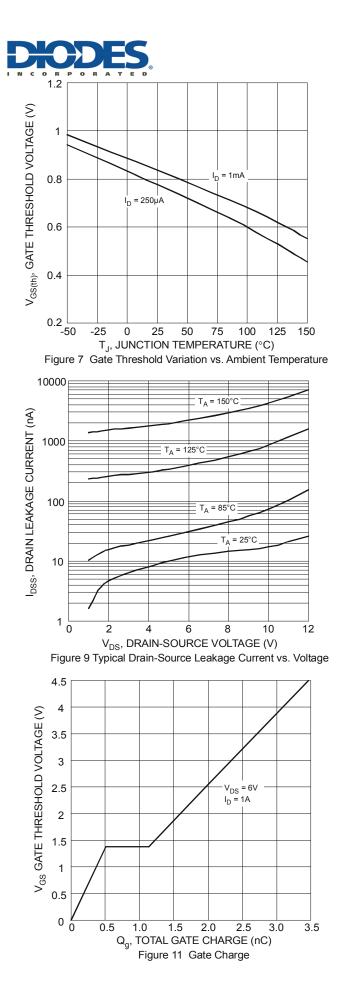
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	12		—	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current TJ = +25°C	I <sub>DSS</sub>	_		1.0	μA	V <sub>DS</sub> = 9.6V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						_
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.4	0.8	1.2	V	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A
			18	26		V <sub>GS</sub> = 4.5V, I <sub>D</sub> =1A
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	21	29	mΩ	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 1A
		_	27	38		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 1A
Forward Transfer Admittance	Y <sub>fs</sub>	_	8.1	—	S	V <sub>DS</sub> = 6V, I <sub>D</sub> = 1A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A
Reverse Recovery Charge	Qrr	_	1.2	—	nC	V <sub>dd</sub> = 5V, I <sub>F</sub> = 1A,
Reverse Recovery Time	t <sub>rr</sub>	_	10.5	—	ns	di/dt =100A/µs
DYNAMIC CHARACTERISTICS (Note 9)			•		•	·
Input Capacitance	C <sub>iss</sub>	_	325	450		
Output Capacitance	Coss	_	183	250	pF	$V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	31	47		1 - 1.00012
Series Gate Resistance	R <sub>G</sub>	_	3.1	—	Ω	f=1MHz,Vgs=0V, Vds=0V
Total Gate Charge	Qg	_	3.2	4.5		
Gate-Source Charge	Q <sub>gs</sub>	_	0.4	—	nC	V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 6V,
Gate-Drain Charge	Q <sub>gd</sub>	_	0.3	—	nc	I <sub>D</sub> =1A
Gate Charge at Vth	Q <sub>g(th)</sub>	_	0.2	—		
Turn-On Delay Time	t <sub>D(on)</sub>		3.3	10		
Turn-On Rise Time	tr	_	5.6	_		V <sub>DS</sub> = 6V, V <sub>GS</sub> = 4.5V,
Turn-Off Delay Time	t <sub>D(off)</sub>	_	24	36	ns	R <sub>G</sub> = 20Ω, I <sub>D</sub> = 1A
Turn-Off Fall Time	t <sub>f</sub>	_	9	—		

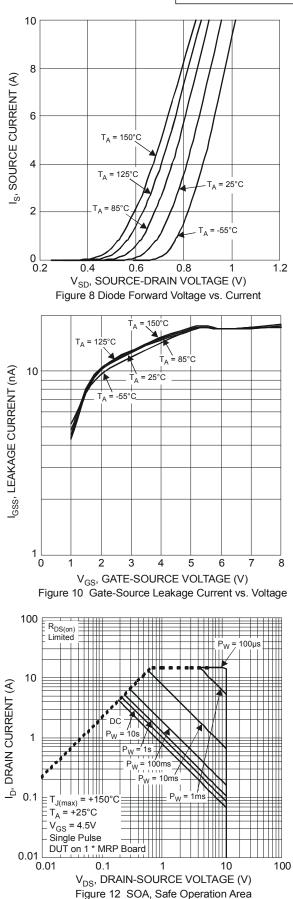
Notes:

Device mounted on FR4 material with 1-inch<sup>2</sup> (6.45-cm<sup>2</sup>), 2-oz. (0.071-mm thick) Cu.
Repetitive rating, pulse width limited by junction temperature.
Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

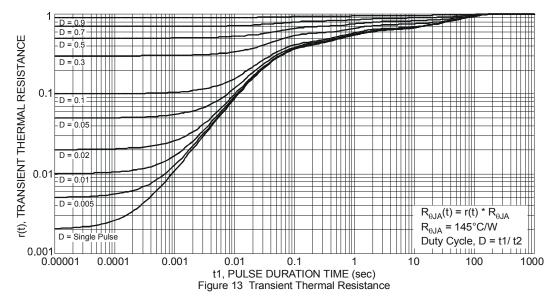






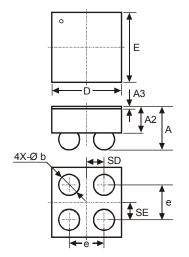






# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

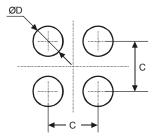


U-WLB1010-4							
Dim	Min	Max	Тур				
D	0.95	1.05	1.00				
E	0.95	1.05	1.00				
Α	_	0.62	-				
A2	-	-	0.38				
A3	0.015	0.025	0.025				
b	0.25	0.35	0.30				
e	-	-	0.50				
SD	-	-	0.25				
SE	-	-	0.25				
All	Dimens	ions in I	nm				

# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### U-WLB1010-4



Dimensions	Value (in mm)
С	0.50
D	0.25



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